



### **N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Features**

- Low Gate Charge
- $R_{DS(ON)}$ : 280m $\Omega$  @  $V_{GS}$  = 4.5V (Single MOSFET)
- 8 N-Channel MOSFET in One Package
- Common Source
- Small Footprint 1.5mm x 1.5mm
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen, Antimony and Beryllium Free. "Green" Device (Note 3)

## **Mechanical Data**

- Case: U-QFN1515-12
- Case Material—Molded Plastic, "Green" Molding

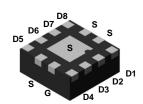
Compound. UL Flammability Classification Rating 94V-0

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe.

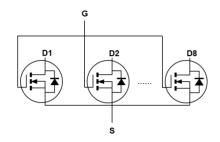
Solderable per MIL-STD-202, Method 208(3)

- Terminal Connections: See Diagram
- Weight: 0.004 grams (Approximate)

### U-QFN1515-12



**Bottom View** 



**Equivalent Circuit** 

## **Ordering Information** (Note 4)

	_	
Part Number	Case	Packaging
DMN1250UFEL-7	U-QFN1515-12	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen, Antimony and Beryllium-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl), <1000ppm antimony compounds and <1000ppm Beryllium.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



# **Marking Information**

Site 1:

## U-QFN1515-12

Α1 YM

A1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: G = 2019)M= Month (ex: 9 = September)

### Date Code Key

Year	2019	2020	2021	2022	2023	2024	2025
Code	O	Н		J	K	L	M

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

Site 2:

### U-QFN1515-12



A1 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 9 = 2019)

W = Week (ex: a = week 27; z represents week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key

	Year	2019	2020	2021	2022	2023	2024	2025	2026	2027
Г	Code	9	0	1	2	3	4	5	6	7

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Green	T	U	V	W	X	Υ	Z
Lead Free	t	u	V	W	Х	у	Z



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characterist	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	12	V	
Gate-Source Voltage	V <sub>GSS</sub>	±8	V	
	T <sub>A</sub> = +25°C		2.0	
Drain Current (Note 6) Continuous	T <sub>A</sub> = +70°C	I <sub>D</sub>	1.6	A
Pulsed Drain Current (Note 7)		I <sub>DM</sub>	10	A
ESD Capability (Note 10)	HBM	150	V	
ESD Capability (Note 10)		CDM	1000	V

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P <sub>D</sub>	0.66	W
Total Power Dissipation (Note 6)	P <sub>D</sub>	1.25	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	177	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	100	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

# **Electrical Characteristics** (@ $T_A = +25$ °C, unless otherwise specified.)

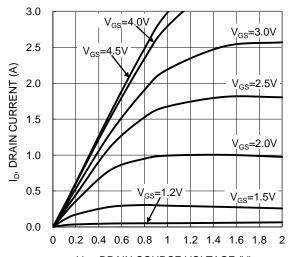
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
STATIC CHARACTERISTICS				•		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	12	_	_	V	$I_D = 250 \mu A, V_{GS} = 0 V$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 12V, V_{GS} = 0V$
Gate-Body Leakage Current	I <sub>GSS</sub>	_	_	±100	nA	$V_{DS} = 0V, V_{GS} = \pm 8V$
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.4	_	1	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Chatia Duair Course On Desistance (Note 9)		_	280	450	mΩ	$V_{GS} = 4.5V, I_D = 0.2A$
Static Drain-Source On-Resistance (Note 8)	R <sub>DS(ON)</sub>	_	360	550	mΩ	$V_{GS} = 2.5V, I_D = 0.1A$
Forward Transfer Admittance	Y <sub>FS</sub>	_	1	_	s	$V_{DS} = 6V, I_D = 0.2A$
Diode Forward Voltage (Note 8)	V <sub>SD</sub>	_	0.8	1.0	V	I <sub>S</sub> = 0.2A, V <sub>GS</sub> = 0V
DYNAMIC CHARACTERISTICS (Note 9)				•		
Input Capacitance	Ciss	_	146	190	pF	
Output Capacitance	Coss	_	10	15	pF	$V_{DS} = 6V, V_{GS} = 0V$ -f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	8	13	pF	-1 = 1.0lvii iz
Gate Resistance	Rg	_	2.4	_	Ω	$V_{GS} = 0V$ , $V_{DS} = 0V$ , $f = 1MHz$
SWITCHING CHARACTERISTICS (Note 9)						
Total Gate Charge	Qg	-	1.3	1.9	nC	
Gate-Source Charge	Q <sub>gs</sub>	_	0.3	_	nC	$V_{GS} = 4.5V, V_{DS} = 6V, I_D = 0.2A$
Gate-Drain Charge	$Q_{gd}$	_	0.1	_	nC	]
Turn-On Delay Time	t <sub>D(ON)</sub>	_	1.9	2.7	ns	
Turn-On Rise Time		_	1.3	_	ns	$V_{DD} = 6V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>		7.5	11	ns	$R_L = 22\Omega$ , $R_g = 6\Omega$
Turn-Off Fall Time	t <sub>F</sub>	_	1.0	_	ns	

Notes:

- 5. Device mounted on 1"  $\times$  1", FR-4 PC board with minimum recommended pad layout, and test with single MOSFET.
- 6. Device mounted on 1"  $\times$  1", FR-4 PC board with 2 oz. copper, and test with single MOSFET.
- $7. \ Repetitive \ Rating, \ pulse \ width \ limited \ by \ junction \ temperature, \ and \ test \ with \ single \ MOSFET.$
- 8. Test pulse width t = 300 ms, test with single MOSFET.
- $9. \ \ \text{Guaranteed by design with single MOSFET}, \ \text{not subject to production testing}.$
- 10. Based on characterization data only. Not subject to production testing.







V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 1. Typical Output Characteristic

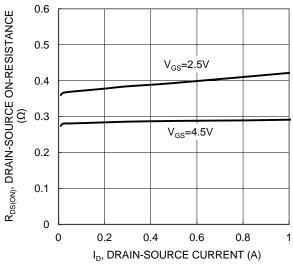


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

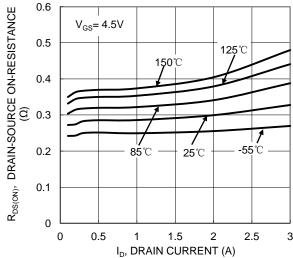
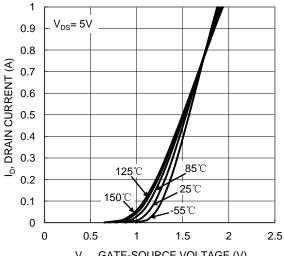
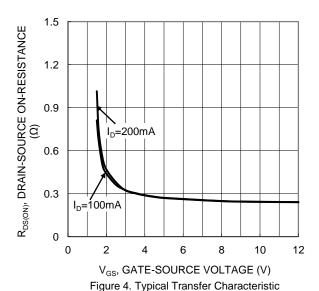


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



V<sub>GS</sub>, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic



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25

-25

-50

0

1.6

Figure 6. On-Resistance Variation with Temperature

50

T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

75

100 125

150



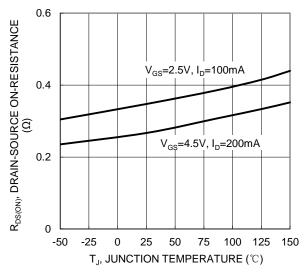


Figure 7. On-Resistance Variation with Temperature

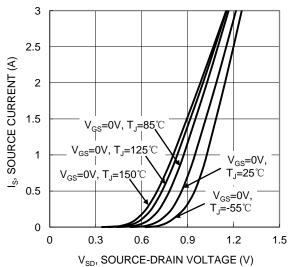
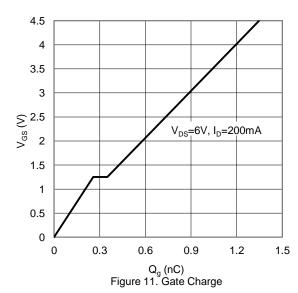


Figure 9. Diode Forward Voltage vs. Current



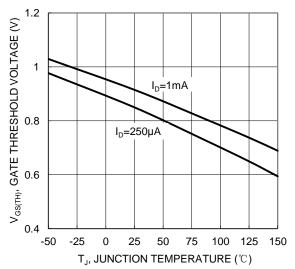
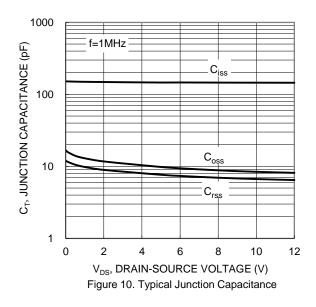
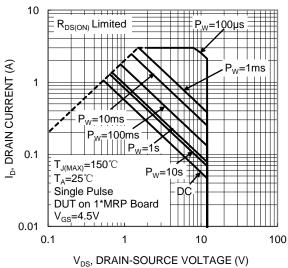


Figure 8. Gate Threshold Variation vs. Junction Temperature





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m V_{DS}},$  DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



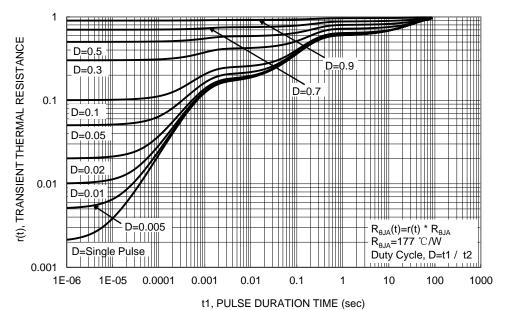


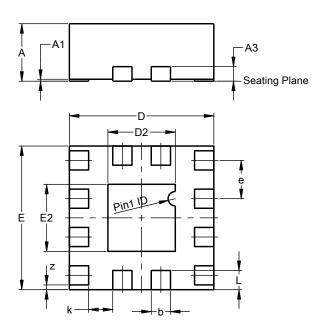
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

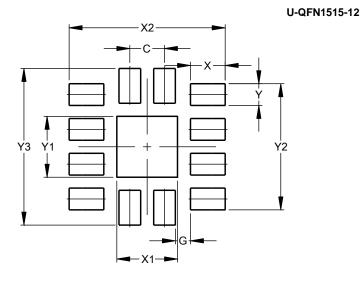
### U-QFN1515-12



	U-QFN1	515-12					
Dim	Min	Max	Тур				
Α	0.57	0.63	0.60				
A1	0.00	0.05	0.02				
А3	0.	152 BS	C				
b	0.15	0.25	0.20				
D	1.45	1.55	1.50				
D2	0.60	0.80	0.70				
Е	1.45	1.55	1.50				
E2	0.60	0.80	0.70				
е	0	.40 BS0					
L	0.15	0.25	0.20				
k	_	_	0.25				
Z	_	_	0.050				
All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value
Dimensions	(in mm)
С	0.400
G	0.175
Х	0.400
X1	0.700
X2	1.800
Υ	0.250
Y1	0.700
Y2	1.450
Y3	1.800



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